

Rail-to-Rail High Output Current Single Operational Amplifier

- Rail-to-rail input and output
- Low noise: $9\text{nV}/\sqrt{\text{Hz}}$
- Low distortion
- High output current: 80mA
(able to drive 32Ω loads)
- High-speed: 4MHz, $1\text{V}/\mu\text{s}$
- Operating from 2.7V to 12V
- ESD internal protection: 1.5kV
- Latch-up immunity
- Macromodel included in this specification

Description

The TS921 is a rail-to-rail single BiCMOS operational amplifier optimized and fully specified for 3V and 5V operation.

Its high output current allows low-load impedances to be driven.

The TS921 exhibits very low noise, low distortion and low offset. It has a high output current capability which makes this device an excellent choice for high quality, low voltage or battery-operated audio systems.

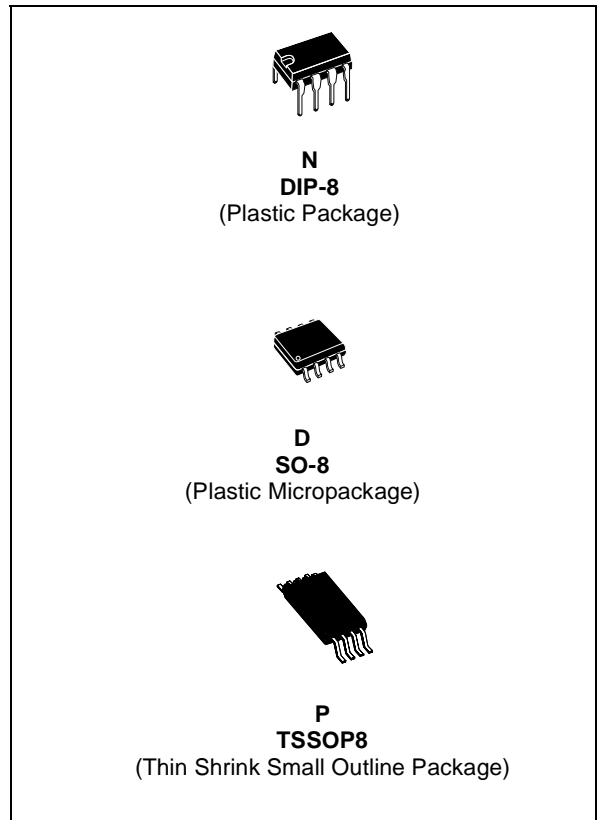
The device is stable for capacitive loads up to 500pF.

Applications

- Headphone amplifier
- Piezoelectric speaker driver
- Sound cards, multimedia systems
- Line driver, actuator driver
- Servo amplifier
- Mobile phone and portable communication sets
- Instrumentation with low noise as key factor

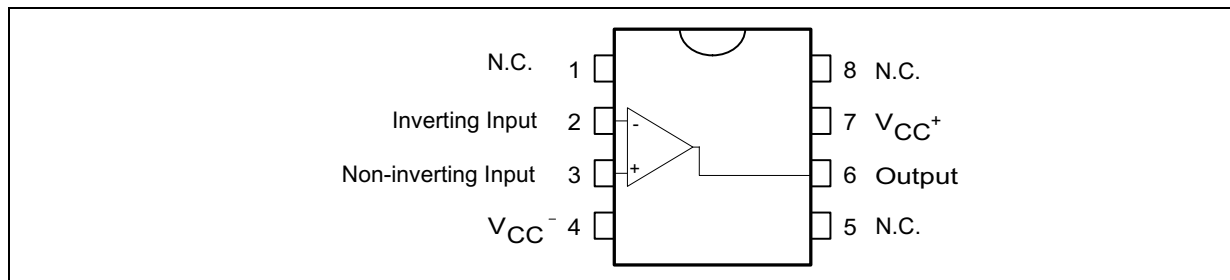
Order Codes

Part Number	Temperature Range	Package	Packaging
TS921IN	-40°C, +125°C	DIP	Tube
TS921ID/IDT		SO	Tube or Tape & Reel
TS921IPT		TSSOP (Thin Shrink Outline Package)	Tape & Reel



1 Pin Diagram

Figure 1 : Pin connections (top view)



2 Absolute Maximum Ratings

Table 1: Key parameters and their absolute maximum ratings

Symbol	Parameter	Value	Unit
VCC	Supply voltage ¹	14	V
V _{id}	Differential Input Voltage ²	±1	V
V _i	Input Voltage	V _{DD} -0.3 to V _{CC} +0.3	V
T _{stg}	Storage Temperature	-65 to +150	°C
T _j	Maximum Junction Temperature	150	°C
R _{thja}	Thermal Resistance Junction to Ambient SO8	125	°C/W
	TSSOP8	120	
	DIP8	85	
ESD	HBM: Human Body Model ³	1.5	kV
	MM: Machine Model ⁴	100	V
	CDM: Charged Device Model	1.5	kV
	Output Short Circuit Duration	see note ⁵	
	Latch-up Immunity	200	mA
	Soldering Temperature (10sec), leaded version	250	°C
	Soldering Temperature (10sec), unleaded version	260	°C

1) All voltages values, except differential voltage are with respect to network ground terminal.

2) Differential voltages are the non-inverting input terminal with respect to the inverting input terminal. If V_{id} > ±1V, the maximum input current must not exceed ±1mA. In this case (V_{id} > ±1V) an input serie resistor must be added to limit input current.

3) Human body model, 100pF discharged through a 1.5kΩ resistor into pin of device.

4) Machine model ESD, a 200pF cap is charged to the specified voltage, then discharged directly into the IC with no external series resistor (internal resistor < 5Ω), into pin to pin of device.

5) There is no short-circuit protection inside the device: short-circuits from the output to V_{cc} can cause excessive heating. The maximum output current is approximately 80mA, independent of the magnitude of V_{cc}. Destructive dissipation can result from simultaneous short-circuits on all amplifiers.

Table 2: OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	2.7 to 12	V
V _{icm}	Common Mode Input Voltage Range	V _{DD} -0.2 to V _{CC} +0.2	V
T _{oper}	Operating Free Air Temperature Range	-40 to +125	°C

3 Electrical Characteristics

Table 3: $V_{CC} = 3V$, $V_{DD} = 0V$, $V_{icm} = V_{CC}/2$, R_L connected to $V_{CC}/2$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage $T_{min.} \leq T_{amb} \leq T_{max.}$			3 5	mV
DV_{io}	Input Offset Voltage Drift		2		$\mu V/^\circ C$
I_{io}	Input Offset Current $V_{out} = 1.5V$			30	nA
I_{ib}	Input Bias Current $V_{out} = 1.5V$		15	100	nA
V_{OH}	High Level Output Voltage $R_L = 600\Omega$ $R_L = 32\Omega$	2.87	2.63		V
V_{OL}	Low Level Output Voltage $R_L = 600\Omega$ $R_L = 32\Omega$		180	100	mV
A_{vd}	Large Signal Voltage Gain ($V_{out} = 2V_{pk-pk}$) $R_L = 600\Omega$ $R_L = 32\Omega$		35 16		V/mV
I_{CC}	Supply Current no load, $V_{out} = V_{cc}/2$		1	1.5	mA
GBP	Gain Bandwidth Product $R_L = 600\Omega$		4		MHz
CMR	Common Mode Rejection Ratio	60	80		dB
SVR	Supply Voltage Rejection Ratio $V_{cc} = 2.7$ to $3.3V$	60	80		dB
I_o	Output Short Circuit Current	50	80		mA
SR	Slew Rate	0.7	1.3		V/ μs
ϕ_m	Phase Margin at Unit Gain $R_L = 600\Omega$, $C_L = 100pF$		68		Degrees
G_m	Gain Margin $R_L = 600\Omega$, $C_L = 100pF$		12		dB
e_n	Equivalent Input Noise Voltage $f = 1kHz$		9		$\frac{nV}{\sqrt{Hz}}$
THD	Total Harmonic Distortion $V_{out} = 2V_{pk-pk}$, $F = 1kHz$, $A_v = 1$, $R_L = 600\Omega$		0.005		%

Table 4: $V_{CC} = 5V$, $V_{DD} = 0V$, $V_{icm} = V_{CC}/2$, R_L connected to $V_{CC}/2$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage $T_{min.} \leq T_{amb} \leq T_{max.}$			3 5	mV
DV_{io}	Input Offset Voltage Drift		2		$\mu V/^\circ C$
I_{io}	Input Offset Current $V_{out} = 1.5V$			30	nA

Table 4: $V_{CC} = 5V$, $V_{DD} = 0V$, $V_{icm} = V_{CC}/2$, R_L connected to $V_{CC}/2$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
I_{ib}	Input Bias Current $V_{out} = 1.5V$		15	100	nA
V_{OH}	High Level Output Voltage $R_L = 32\Omega$ $R_L = 600\Omega$	4.85	4.4		V
V_{OL}	Low Level Output Voltage $R_L = 32\Omega$ $R_L = 600\Omega$		300	120	mV
A_{vd}	Large Signal Voltage Gain ($V_{out} = 2V_{pk} - V_{pk}$) $R_L = 32\Omega$ $R_L = 600\Omega$		35 16		V/mV
I_{cc}	Supply Current no load, $V_{out} = V_{CC}/2$		1	1.5	mA
GBP	Gain Bandwidth Product $R_L = 600\Omega$		4		MHz
CMR	Common Mode Rejection Ratio	60	80		dB
SVR	Supply Voltage Rejection Ratio $V_{CC} = 4.5$ to $5.5V$	60	80		dB
I_o	Output Short Circuit Current	50	80		mA
SR	Slew Rate	0.7	1.3		V/ μs
ϕ_m	Phase Margin at Unit Gain $R_L = 600\Omega$, $C_L = 100pF$		68		Degrees
G_m	Gain Margin $R_L = 600\Omega$, $C_L = 100pF$		12		dB
e_n	Equivalent Input Noise Voltage $f = 1kHz$		9		$\frac{nV}{\sqrt{Hz}}$
THD	Total Harmonic Distortion $V_{out} = 2V_{pk-pk}$, $F = 1kHz$, $A_v = 1$, $R_L = 600\Omega$		0.005		%

Table 5: $V_{CC} = 3V$, $V_{DD} = 0V$, R_L , C_L connected to $V_{CC}/2$, $T_{amb} = 25^{\circ}C$ (unless otherwise specified)

Symbol	Conditions	Value	Unit
V_{io}		0	mV
A_{vd}	$R_L = 10k\Omega$	200	V/mV
I_{CC}	No load, per operator	1.2	mA
V_{icm}		-0.2 to 3.2	V
V_{OH}	$R_L = 10k\Omega$	2.95	V
V_{OL}	$R_L = 10k\Omega$	25	mV
I_{sink}	$V_O = 3V$	80	mA
I_{source}	$V_O = 0V$	80	mA
GBP	$R_L = 600k\Omega$	4	MHz
SR	$R_L = 10k\Omega$, $C_L = 100pF$	1.3	V/ μs
ϕ_m	$R_L = 600k\Omega$	68	Degrees

Figure 1: Output Short Circuit Current vs Output Voltage

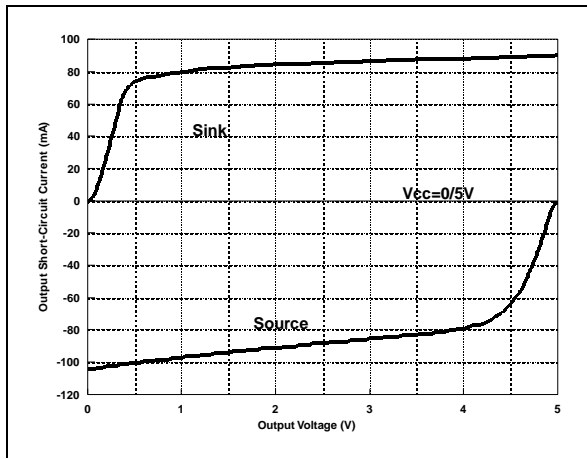


Figure 2: Output Short Circuit Current vs Output Voltage

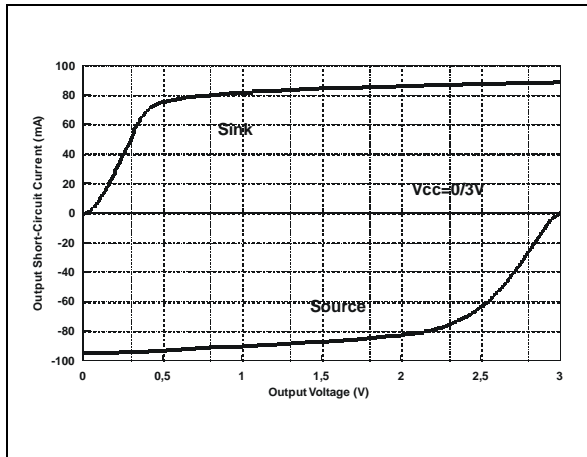


Figure 3: Output Supply Current vs Supply Voltage

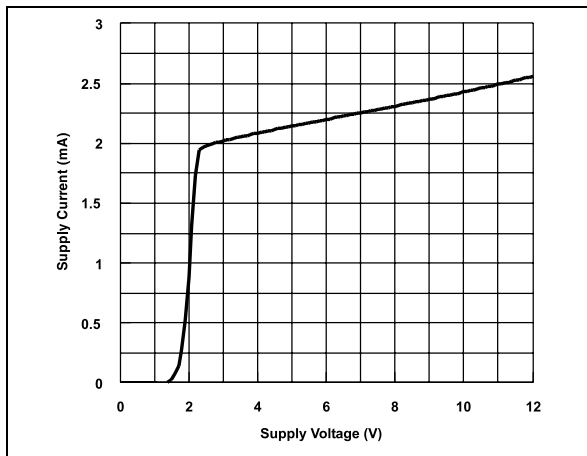


Figure 4: Voltage Gain And Phase vs Frequency

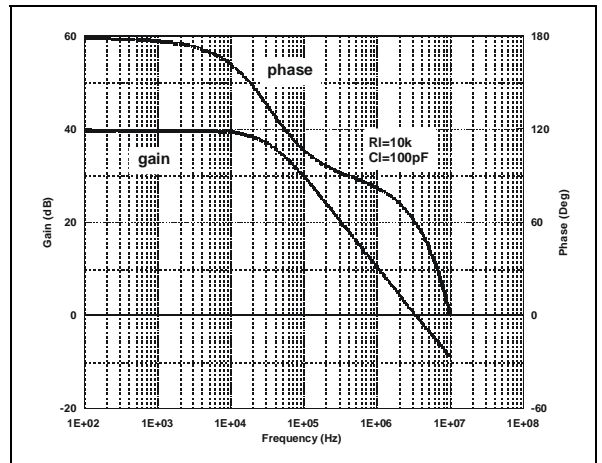


Figure 5: Equivalent Input Noise Voltage vs Frequency

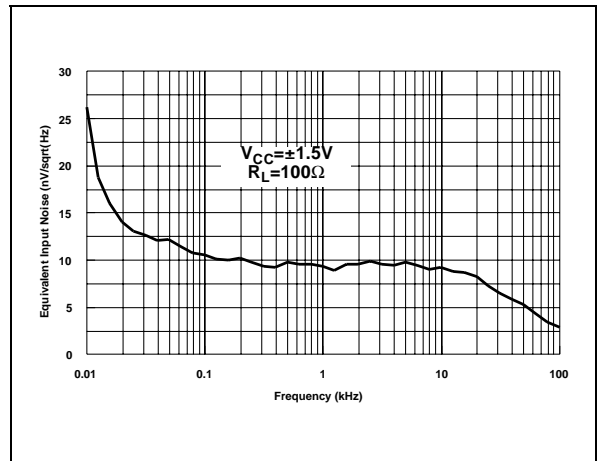


Figure 6: THD + Noise vs Frequency

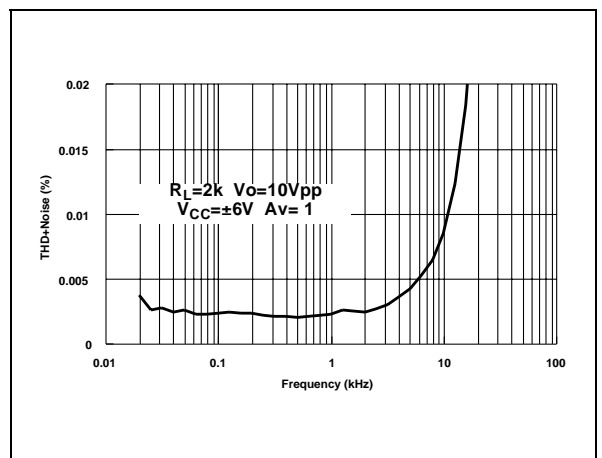


Figure 7: THD + Noise vs Frequency

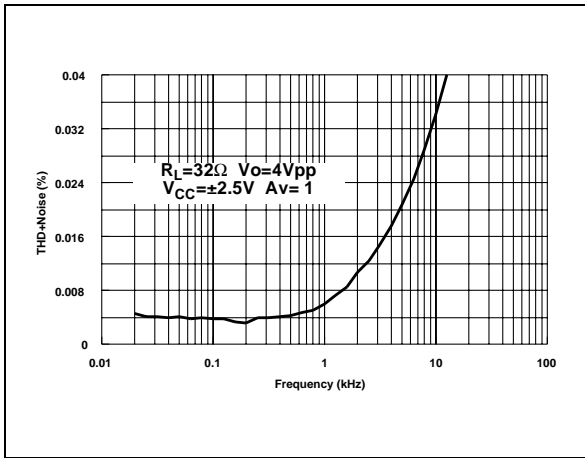


Figure 10: THD Noise vs Output Voltage

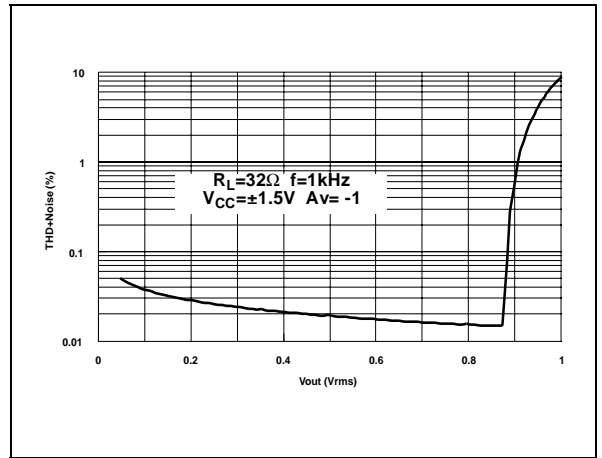


Figure 8: THD + Noise vs Frequency

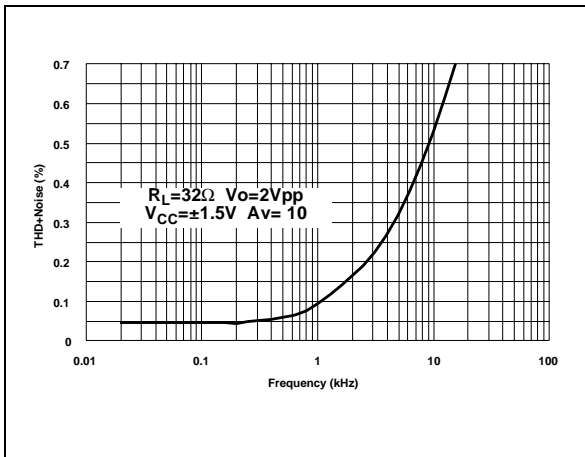


Figure 11: THD Noise vs Output Voltage

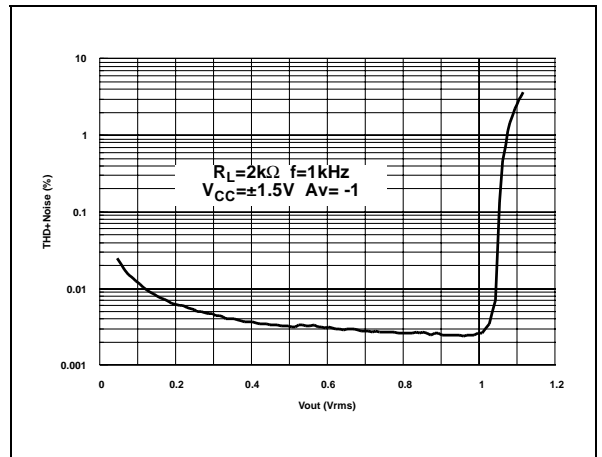


Figure 9: THD Noise vs Output Voltage

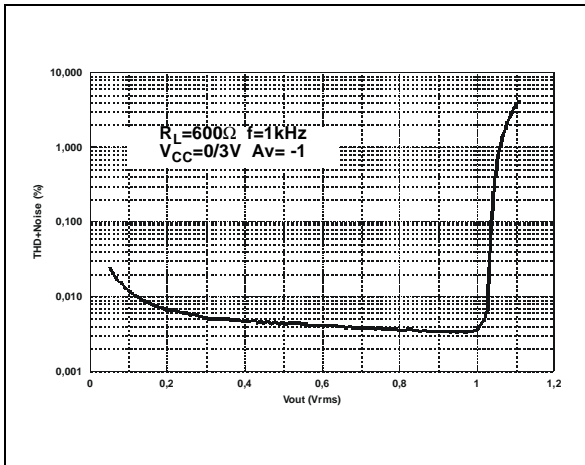
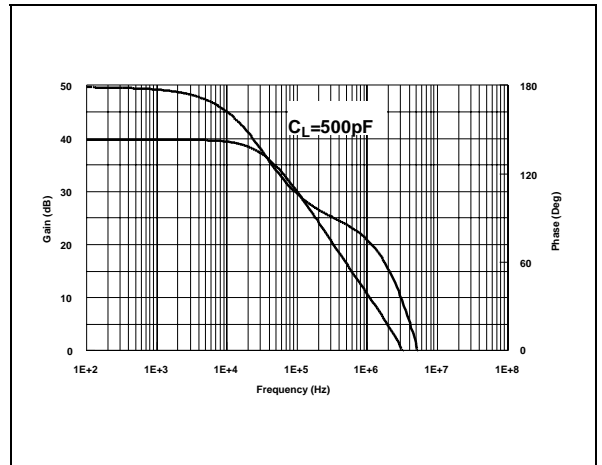


Figure 12: Open Loop Gain and Phase vs Frequency



4 Macromodels



Warning: Please consider following remarks before using this macromodel:

All models are a trade-off between accuracy and complexity (i.e. simulation time).

Macromodels are not a substitute to breadboarding; rather, they confirm the validity of a design approach and help to select surrounding component values.

A macromodel emulates the NOMINAL performance of a TYPICAL device within SPECIFIED OPERATING CONDITIONS (i.e. temperature, supply voltage, etc.). Thus the macromodel is often not as exhaustive as the datasheet, its goal is to illustrate the main parameters of the product.

Data issued from macromodels used outside of its specified conditions (Vcc, Temperature, etc) or even worse: outside of the device operating conditions (Vcc, Vicm, etc) are not reliable in any way.

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** Standard Linear Ics Macromodels, 1996.
** CONNECTIONS:
* 1 INVERTING INPUT
* 2 NON-INVERTING INPUT
* 3 OUTPUT
* 4 POSITIVE POWER SUPPLY
* 5 NEGATIVE POWER SUPPLY
.SUBCKT TS921 1 3 2 4 5 (analog)
*****.MODEL MDTH D IS=1E-
8 KF=2.664234E-16 CJO=10F
* INPUT STAGE
CIP 2 5 1.000000E-12
CIN 1 5 1.000000E-12
EIP 10 5 2 5 1
EIN 16 5 1 5 1
RIP 10 11 8.125000E+00
RIN 15 16 8.125000E+00
RIS 11 15 2.238465E+02
DIP 11 12 MDTH 400E-12
DIN 15 14 MDTH 400E-12
VOFP 12 13 DC 153.5u
VOFN 13 14 DC 0
IPOL 13 5 3.200000E-05
CPS 11 15 1e-9
DINN 17 13 MDTH 400E-12
VIN 17 5 -0.100000e+00
DINR 15 18 MDTH 400E-12
VIP 4 18 0.400000E+00
FCP 4 5 VOFP 1.865000E+02
FCN 5 4 VOFN 1.865000E+02
FIBP 2 5 VOFP 6.250000E-03
FIBN 5 1 VOFN 6.250000E-03
* GM1 STAGE *****
FGM1P 119 5 VOFP 1.1
FGM1N 119 5 VOFN 1.1
RAP 119 4 2.6E+06
RAN 119 5 2.6E+06
* GM2 STAGE *****
G2P 19 5 119 5 1.92E-02
G2N 19 5 119 4 1.92E-02
R2P 19 4 1E+07
R2N 19 5 1E+07
*****

```



```

VINT1 500 0 5
GCONVP 500 501 119 4 19.38!send ds VP, I(VP)=(V119-V4)/2/Ut VP 501 0 0
GCONVN 500 502 119 5 19.38!send ds VN, I(VN)=(V119-V5)/2/Ut VN 502 0 0
***** orientation isink isource *****
VINT2 503 0 5
FCOPY 503 504 VOUT 1
DCOPYP 504 505 MDTH 400E-9
VCOYP 505 0 0
DCOPYN 506 504 MDTH 400E-9
VCOYPN 0 506 0
*****
F2PP 19 5 poly(2) VCOYP VP 0 0 0 0 0.5!multiply I(vout)*I(VP)=Iout*(V119-V4)/
2/Ut
F2PN 19 5 poly(2) VCOYP VN 0 0 0 0 0.5 !multiply I(vout)*I(VN)=Iout*(V119-
V5)/2/Ut
F2NP 19 5 poly(2) VCOYPN VP 0 0 0 0 1.75 !multiply I(vout)*I(VP)=Iout*(V119-
V4)/2/Ut
F2NN 19 5 poly(2) VCOYPN VN 0 0 0 0 1.75 !multiply I(vout)*I(VN)=Iout*(V119-
V5)/2/Ut
* COMPENSATION *****
CC 19 119 25p
* OUTPUT*****
DOPM 19 22 MDTH 400E-12
DONM 21 19 MDTH 400E-12
HOPM 22 28 VOUT 6.250000E+02
VIPM 28 4 5.000000E+01
HONM 21 27 VOUT 6.250000E+02
VINM 5 27 5.000000E+01
VOUT 3 23 0
ROUT 23 19 6
COUT 3 5 1.300000E-10
DOP 19 25 MDTH 400E-12
VOP 4 25 1.052
DON 24 19 MDTH 400E-12
VON 24 5 1.052
.ENDS

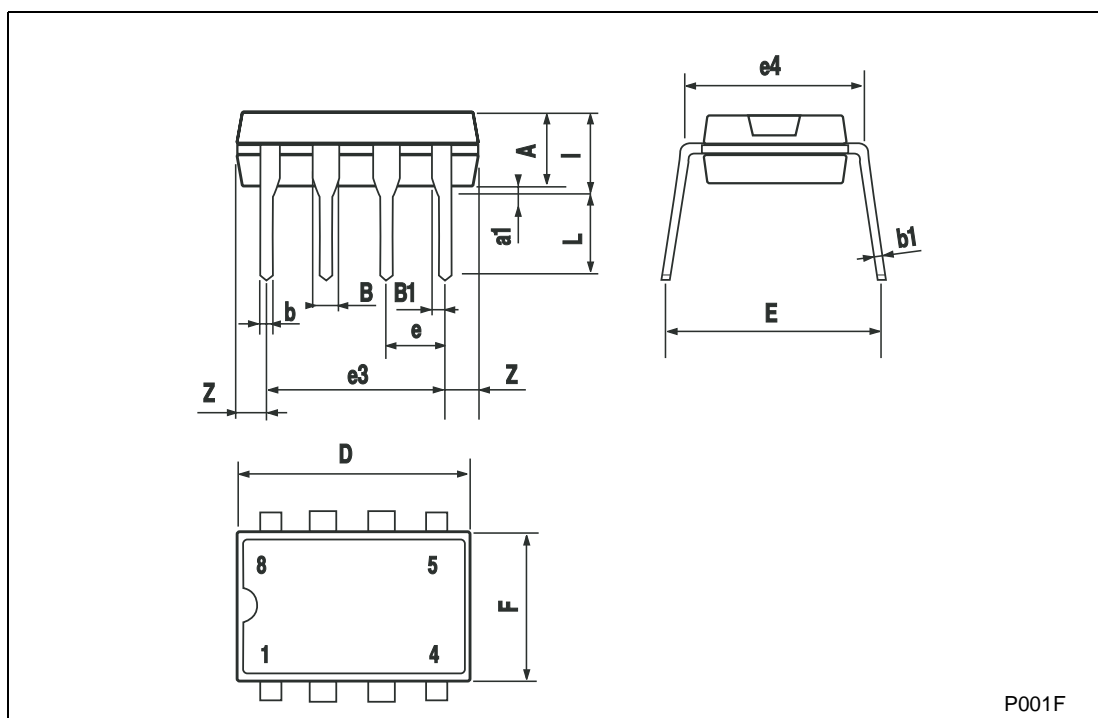
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5 Package Mechanical Data

5.1 DIP8 package

Plastic DIP-8 MECHANICAL DATA

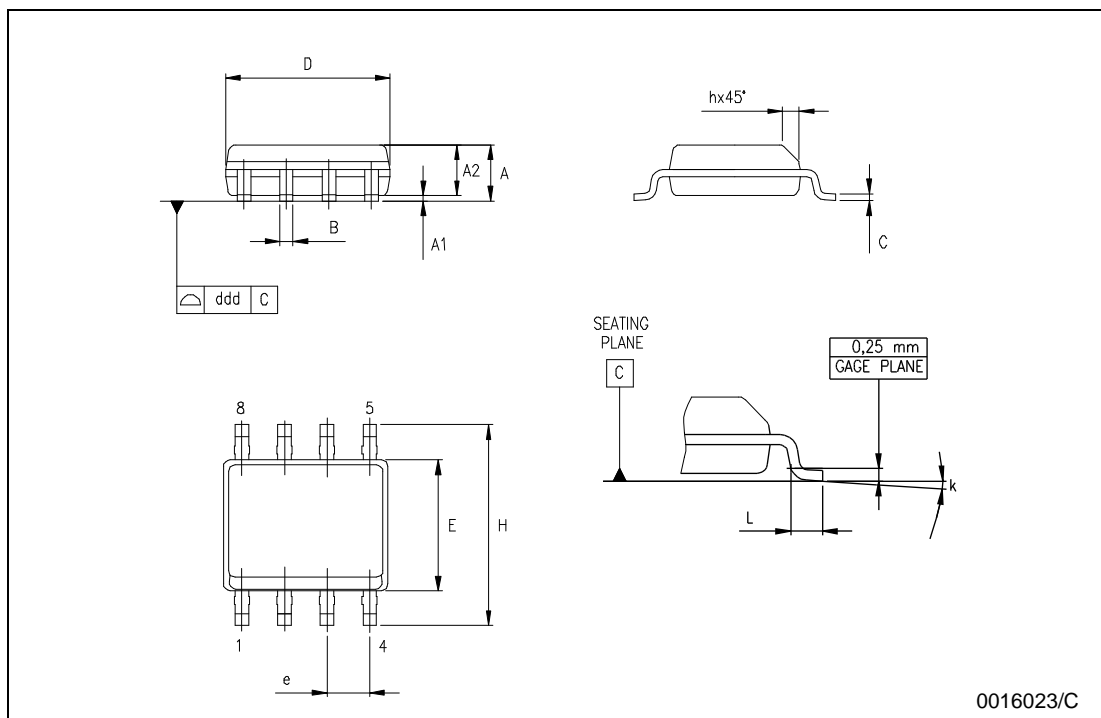
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A		3.3			0.130	
a1	0.7			0.028		
B	1.39		1.65	0.055		0.065
B1	0.91		1.04	0.036		0.041
b		0.5			0.020	
b1	0.38		0.5	0.015		0.020
D			9.8			0.386
E		8.8			0.346	
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			7.1			0.280
I			4.8			0.189
L		3.3			0.130	
Z	0.44		1.6	0.017		0.063



5.2 SO8 package

SO-8 MECHANICAL DATA

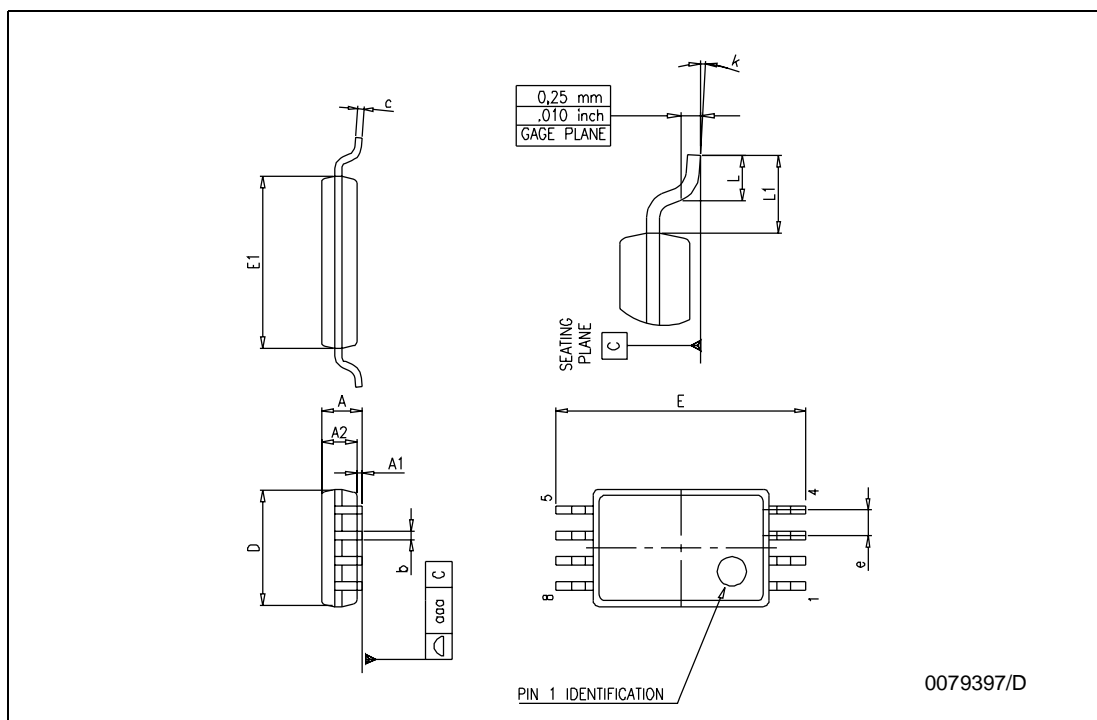
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
B	0.33		0.51	0.013		0.020
C	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
e		1.27			0.050	
H	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	g° (max.)					
ddd			0.1			0.04



5.3 TSSOP8 package

TSSOP8 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.008
D	2.90	3.00	3.10	0.114	0.118	0.122
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.0256	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1			0.039	



6 Summary of Changes

Date	Revision	Description of Changes
01 Feb 2001	1	First Release
01 Dec 2004	2	Modifications on AMR table page 2 (explanation of Vid and Vi limits, ESD MM and CDM values added, Rthja added)

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